



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Application Number : 10/724,133 Confirmation No. 1214
Applicant : Joon Hyeon LEE
Filed : December 1, 2003
Tech Cntr/AU : 1765
Examiner : Duy Vu Nguyen Deo
Entitled : METHOD OF FORMING METAL LINE LAYER IN SEMICONDUCTOR DEVICE
Attorney Reference : 123034-05004921
Customer Number : 43569

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

AMENDMENT/RESPONSE TRANSMITTAL

Transmitted herewith is an amendment/response for this application.

EXTENSION OF TIME

A petition for extension of time under 37 C.F.R. 1.136 is not believed necessary.

CLAIM FEES

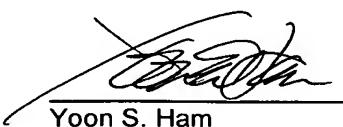
The claim fees have been calculated as follows:

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total	11	-	20	= 0 x \$ 50.00	= \$ 0.00
Independent	1	-	3	= 0 x \$ 200.00	= \$ 0.00
FIRST PRESENTATION OF MULTIPLE DEP. CLAIM+			\$ 360.00	= \$	<u>0.00</u>
TOTAL ADDITIONAL CLAIM FEE DUE				\$	0.00

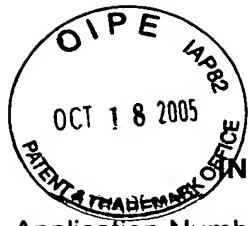
FEE PAYMENT

Authorization is given herein to charge the any deficiencies in the fees not specifically authorized herein, or to further credit any overpayments, to Deposit Account No. 503-121 in order to maintain the pendency of this application.

Intellectual Property Department
Mayer Brown Rowe & Maw LLP
1909 K Street, N.W.
Washington, D.C. 20006-1101


Yoon S. Ham
Registration No. 45,307
(202) 263-3280

Date: October 18, 2005



IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Application Number : 10/724,133 Confirmation No. 1214
Applicant : Joon Hyeon LEE
Filed : December 1, 2003
Tech Cntr/AU : 1765
Examiner : Duy Vu Nguyen Deo
Entitled : METHOD OF FORMING METAL LINE LAYER IN SEMICONDUCTOR DEVICE
Attorney Reference : 123034-05004921
Customer Number : 43569

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

RESPONSE UNDER 37 C.F.R. § 1.111

Sir:

In response to the Office Action dated July 20, 2005 for the above-identified application, amendments and/or remarks submitted herewith include:

- In the Drawings;
- A complete claim listing; and
- Remarks and arguments.